

OPS72E

OPS ON BOARD COMPUTER

Hisense interactive displays feature an integrated OPS slot, allowing a powerful on-board PC to be seamlessly embedded. Equipped with high-performance Intel® processor, the OPS delivers desktop-level performance within the display, ensuring enhanced flexibility, broad compatibility, and streamlined deployment.



Highlights



13th Gen Intel Core Processor

Powered by a 13th Gen Intel Core processor, delivering high-performance computing and efficient multitasking.



High Speed Storage

Fast data access and ample storage capacity (16GB+512GB) enables smooth and reliable performance for demanding applications.



WiFi 6 & Bluetooth 5.3 connectivity

Ultra-fast wireless connectivity with WiFi 6 and stable, low-latency device pairing via Bluetooth 5.3.



Multi-Interface expansion capability

Supports a wide range of interfaces for flexible connection to external devices.



Enhanced productivity & Security

Built on Windows 11 Pro, the OPS enhances productivity with advanced security, smooth multitasking, and remote management via Hisense VisionInfo.



Energy-Efficient Operation

Delivers energy-efficient performance under demanding workloads, achieving an optimal balance between power consumption and performance.



Specifications

OPS

Model Name	OPS72E
CPU	Intel Core™ I7-13620H
RAM	16GB
SSD	512GB
LAN	Integrated 10/100/1000M Adaption
WIFI	WIFI 6
Bluetooth	Bluetooth 5.3
USB 3.0	4
USB 2.0	/
Type-C	1
HDMI out	1 (2.0)
DP out	1 (1.4)
VGA	/
Mic in	1
Line out	1
HDD LED	1
Power LED	1
Power Requirements	12V-19V DC
Max Power	90 W
Standby Power	2.9 W
Color	Black
Product Dimension (LxWxH)	180 x 119 x 30 mm
Package Dimension (LxWxH)	267 x 192 x 72 mm
Net Weight	0.60kg
Gross Weight	0.97kg
Operation Temperature	-10°C - 45°C
Operation Humidity	10%-90%
Storage Temperature	-20°C - 60°C
Storage Humidity	10% - 90%
System	Win11-Pro
Certification	CB / CE / UKCA / FCC / IC / RCM / Rohs / UL4200A
Adaptive Model	65/75/86WE3FE, 65/75/86WM6FE-A, 65/75/86WE6GE, 100WE6GE

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